Accepted Manuscript

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Yinhang Zhang, Jang Rak Choi, Soo-Jin Park

PII:	S1359-835X(17)30244-0
DOI:	http://dx.doi.org/10.1016/j.compositesa.2017.06.019
Reference:	JCOMA 4706
To appear in:	Composites: Part A
Received Date:	8 April 2017
Revised Date:	7 June 2017
Accepted Date:	16 June 2017



Please cite this article as: Zhang, Y., Rak Choi, J., Park, S-J., Thermal conductivity and thermo-physical properties of nanodiamond-attached exfoliated hexagonal boron nitride/epoxy nanocomposites for microelectronics, *Composites: Part A* (2017), doi: http://dx.doi.org/10.1016/j.compositesa.2017.06.019

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ACCEPTED MANUSCRIPT

Manuscript submitted to "Composites part A" as an original paper

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Yinhang Zhang, Jang Rak Choi and Soo-Jin Park

Department of Chemistry, Inha University, 100 Inharo, Incheon 22212, Korea

MP

* Corresponding authors. Tel.: +82-32-860-8438; Fax: +82-32-860-8438.

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E-mail addresses: <u>sipark@inha.ac.kr</u>(S. -J. Park)

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